

# East 0 USPBUSPT

Number	Hits	Search Text	DB	Time stamp
2	28629	bond\$ with pad	USPAT; US-PGPUB	2004/10/14 17:52
3	2272803	etch\$ or patern\$ or remov\$	USPAT; US-PGPUB	2004/10/14 17:52
4	388376	resist or photoresist or mask or photomask	USPAT; US-PGPUB	2004/10/14 17:52
5	1654	(bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)	USPAT; US-PGPUB	2004/10/14 17:53
6	281	solder same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask))	USPAT; US-PGPUB	2004/10/14 17:53
7	295	solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask))	USPAT; US-PGPUB	2004/10/14 17:54
9	240	(solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask))) not (adhes\$ same (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask))))	USPAT; US-PGPUB	2004/10/14 19:14
10	11328	(etch\$ or patern\$ or remov\$) with passivat\$	USPAT; US-PGPUB	2004/10/14 19:15
11	46896	contact with pad	USPAT; US-PGPUB	2004/10/14 19:15
12	492	((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)	USPAT; US-PGPUB	2004/10/14 19:16
13	459	((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask) not (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)))	USPAT; US-PGPUB	2004/10/14 19:17
14	2711	((etch\$ or patern\$ or remov\$) with passivat\$) with (resist or photoresist or mask or photomask)	USPAT; US-PGPUB	2004/10/14 19:17
15	375	((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask) same (((etch\$ or patern\$ or remov\$) with passivat\$) with (resist or photoresist or mask or photomask))	USPAT; US-PGPUB	2004/10/14 19:17
16	362	((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask) not (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask))) and (((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)) same (((etch\$ or patern\$ or remov\$) with passivat\$) with (resist or photoresist or mask or photomask))	USPAT; US-PGPUB	2004/10/14 19:18
17	239	((etch\$ or patern\$ or remov\$) with passivat\$) with (resist or photoresist or mask or photomask) with ((bond\$ with pad) or (contact with pad))	USPAT; US-PGPUB	2004/10/14 19:18
18	239	((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask) same (((etch\$ or patern\$ or remov\$) with passivat\$) with (resist or photoresist or mask or photomask)) with ((bond\$ with pad) or (contact with pad))	USPAT; US-PGPUB	2004/10/14 19:18

19	232	(((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)) same (((etch\$ or patern\$ or remov\$) with passivat\$) with (resist or photoresist or mask or photomask)) with ((bond\$ with pad) or (contact with pad)))) not (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)))	USPAT; US-PGPUB	2004/10/14 21:00
8	55	adhes\$ same (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)))	USPAT; US-PGPUB	2004/10/14 20:33
20	227	(((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)) not ((((((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)) same (((etch\$ or patern\$ or remov\$) with passivat\$) with (resist or photoresist or mask or photomask)) with ((bond\$ with pad) or (contact with pad)))) not (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)))) or (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask))))	USPAT; US-PGPUB	2004/10/14 21:02
21	227	(((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)) not ((((((bond\$ with pad) or (contact with pad)) same ((etch\$ or patern\$ or remov\$) with passivat\$) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)) same (((etch\$ or patern\$ or remov\$) with passivat\$) with (resist or photoresist or mask or photomask)) with ((bond\$ with pad) or (contact with pad)))) not (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)))) or (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask)))) not (adhes\$ same (solder\$ same ((bond\$ with pad) same (etch\$ or patern\$ or remov\$) same (resist or photoresist or mask or photomask))))	USPAT; US-PGPUB	2004/10/14 21:02